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Combinatorial synthesis and characterization of thin film $\text{Al}_{1-x}\text{RE}_x\text{N}$ ($\text{RE} = \text{Pr}^{3+}$ and Tb^{3+}) heterostructural alloys†

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The potential impact of cation-substituted AlN-based materials, such as $\text{Al}_{1-x}\text{Sc}_x\text{N}$, $\text{Al}_{1-x}\text{Ga}_x\text{N}$, and $\text{Al}_{1-x}\text{B}_x\text{N}$, with exceptional electronic, electromechanical, and dielectric properties has spurred research into this broad family of materials. Rare earth (RE) cations are particularly appealing as they could additionally impart optoelectronic or magnetic functionality. However, success in incorporating a significant level of RE cations into AlN has been limited so far because it is thermodynamically challenging to stabilize such heterostructural alloys. Using combinatorial co-sputtering, we synthesized $\text{Al}_{1-x}\text{RE}_x\text{N}$ ($\text{RE} = \text{Pr}, \text{Tb}$) thin films and performed a rapid survey of the composition–structure–property relationships as a function of RE substitution. Under our growth conditions, we observe that $\text{Al}_{1-x}\text{Pr}_x\text{N}$ maintains a phase-pure wurtzite structure until transitioning to amorphous for $x \gtrsim 0.22$. $\text{Al}_{1-x}\text{Tb}_x\text{N}$ exhibits a phase-pure wurtzite structure until $x \lesssim 0.15$, then exhibits mixed wurtzite and rocksalt phases for $0.16 \lesssim x \lesssim 0.28$, and finally becomes amorphous beyond that. Ellipsometry measurements reveal that the absorption onset decreases with increasing rare earth incorporation and has a strong dependence on the phases present. We observe the characteristic cathodoluminescence emission of Pr^{3+} and Tb^{3+} , respectively. Using this synthesis approach, we have demonstrated incorporation of Pr and Tb into the AlN wurtzite structure up to higher compositions levels than previously reported and made the first measurements of corresponding structural and optoelectronic properties.

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Introduction

Wurtzite-structured (wz) III-nitrides such as AlN and GaN have garnered significant attention as next-generation semiconductors thanks to their wide bandgaps (6.4 and 3.4 eV, respectively), high mobilities, and exceptional thermal properties. These materials show great promise for high voltage – high frequency power electronics and superior opto(electronic) applications,^{1,2} including high mobility electron transistors (HEMT)³ and LEDs. AlN is also indispensable in micro-electromechanical systems (MEMS)⁴ and radio frequency communications for acoustic resonators and filter devices,⁵ and significant performance enhancements have been realized *via* alloying with ScN.^{6,7} This has driven increased research interest

in creating and understanding heterostructural alloys (*i.e.*, $\text{III}_{1-x}\text{M}_x\text{N}$, $\text{M} = \text{metal}$) between wurtzite AlN and end members that are stable in competing non-wurtzite MN phases.⁸ This interest accelerated in the last five years with the first report of wurtzite ferroelectricity in $\text{Al}_{1-x}\text{Sc}_x\text{N}$,⁹ and later $\text{Zn}_{1-x}\text{Mg}_x\text{O}$,¹⁰ $\text{Al}_{1-x}\text{B}_x\text{N}$,¹¹ $\text{Ga}_{1-x}\text{Sc}_x\text{N}$,¹² and $\text{Al}_{1-x}\text{Y}_x\text{N}$.¹³

Rare earth (RE) elements are particularly interesting as alloying options because of the potential for introducing specific magnetic and/or optoelectronic characteristics not typically found in III-nitrides.^{14,15} In addition, rare earth-containing alloys in general are of interest for a wide range of other applications, including structural materials and catalysis.^{16,17} Recent calculations on Gd-, Tb-, and Pr-substituted AlN and GaN alloys predicted that the wurtzite structure remains the lowest-energy crystalline phase across a broad compositional space,¹⁸ but the inherent thermodynamic instability of the alloy requires kinetic control to form and maintain single phase samples. Synthesis and characterization of $\text{Al}_{1-x}\text{RE}_x\text{N}$ alloys across the RE^{3+} cation series thus remains very limited.

Previous studies attempting to incorporate trivalent REs into a wurtzite AlN lattice had limited and often narrow

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compositional ranges.^{14,19–21} Many such studies used ion implantation of the REs into AlN films initially fabricated by sputtering, MBE, or MOCVD^{22–26} followed by post-implantation annealing. The highest concentrations of Tb in AlN with pure phase previously reported were <1 at% in a powder AlN:Tb phosphor that also showed evidence of an unidentified secondary phase^{21,27} and 11 at% (*i.e.*, $x \approx 0.11$) in thin films deposited from DC sputtering, though the crystalline phase of these films is unknown.²⁸ As such, a fundamental understanding of the composition-phase-property relationship(s) within this family is lacking. High throughput combinatorial synthesis is a powerful tool to quickly survey broader phase spaces and perform initial systematic studies of structure(s) and properties across the composition range. Our previous work successfully explored one member of this family by demonstrating the incorporation of Gd³⁺ cations ions up to ~24% in wz-AlN. DFT calculations predicted similar mixing enthalpies for wz-Al_{1-x}RE_xN (RE = Gd, Pr, Tb), suggesting that experimental incorporation is likely achievable. Exploring similarly high substitution levels with other RE³⁺ cations will further expand the current understanding of the effects of ionicity, size mismatches, and chemistries in Al_{1-x}RE_xN films.

Optoelectronic properties are of particular interest for Al_{1-x}RE_xN thin films, as the large bandgap of the AlN host lattice offers a wide range of application options for utilizing the sharp well-defined emissions from RE internal 4f transitions²⁹ spanning UV to IR regions.^{30–36} In addition, given the intriguing magnetic ground states in rocksalt (rs) structured-REs such as ferromagnetism in GdN and TbN,^{37,38} studying their alloys with wz-AlN could potentially unlock interesting magnetic phenomena.

Here, we report the combinatorial synthesis of Al_{1-x}RE_xN (RE = Pr, Tb) thin films *via* radio frequency (RF) co-sputtering. Common synthesis conditions were employed to enable comparison between the RE cations. This yielded films with a broad range of x , allowing us to perform a rapid, systematic exploration of the phase space and investigate property trends across the composition range. Scanning/transmission electron microscope (S/TEM) imaging with energy-dispersive X-ray spectroscopy (EDS) mapping reveals polycrystalline films with uniform RE incorporation. We report the growth of single-phase wurtzite Al_{1-x}RE_xN (RE = Pr, Tb) films up to $x \lesssim 0.22$ and $x \lesssim 0.15$, respectively, despite the large ionic size mismatches. Al_{1-x}Tb_xN phase separates into wz + rs phases for $0.16 \lesssim x \lesssim 0.28$ and is amorphous for higher RE content ($x \gtrsim 0.28$), while Al_{1-x}Pr_xN films have a direct crossover from crystalline wz to amorphous at $x \gtrsim 0.22$ with no evidence of any crystalline rs phase. Spectroscopic ellipsometry shows an expected decrease of the absorption onset on the amount of RE incorporation and the phases present. Cathodoluminescence (CL) measurements further confirm the RE³⁺ incorporation within the films and suggest that incorporation of the RE emitters directly into the wz host lattice may provide additional ways to control the ratio of radiative to non-radiative recombination among the various emission lines or *via* co-doping strategies. This work reports wz-Al_{1-x}RE_xN (RE = Pr, Tb) films up to the highest levels of RE

incorporation reported to date with associated data on absorption and emission spectra across composition and phase space.

Experimental

Synthesis

Combinatorial thin films of Al_{1-x}RE_xN (RE = Pr and Tb) were synthesized using radio frequency co-sputtering of metallic Al (99.999%, Kurt J. Lesker) and Pr or Tb (99.9%, QS Advanced Materials) targets from 2" magnetrons within a sputtering chamber with a base pressure of $\sim 8 \times 10^{-8}$ Torr. The magnetrons were in a standard balanced magnetron configuration and placed at a 180° angle to each other. Films were grown on 5.08 × 5.08 cm p-type Si(100) (pSi) substrates with native SiO₂ layers that were heated to approximately 600 °C. A cryogenic sheath was employed to trap adventitious oxygen or water during deposition. The targets were pre-sputtered for 45–120 minutes with the substrate shutter closed before depositing for 120 minutes. The Al target power was kept constant at 150 W for all depositions, while powers to RE targets were 20, 40, and 60 W. All films were deposited at a constant gas ratio of Ar:N₂ = 2:1 (40:20 sccm) at a process pressure of 4 mTorr. The substrates were kept stationary to create a 1D composition gradient. After the depositions, the substrates were cooled in a N₂ environment at a pressure of 8 mTorr until the substrate temperature reached <100 °C.

Characterization

Experimental data of the combinatorial films were analyzed using the COMBIgor software package³⁹ and are publicly available in the National Renewable Energy Laboratory (NREL) high throughput experimental materials database.^{40,41}

Cation composition was measured with X-ray fluorescence (XRF) using a Bruker M4 Tornado under vacuum (~ 15 Torr). Thicknesses were extracted from the XRF data following calibration of the model with transmission electron microscopy (TEM). The average elemental composition was analyzed at the University of Oregon Center for Advanced Materials Characterization in Oregon (CAMCOR) using a Cameca SX100 electron probe microanalyzer (EPMA) with wavelength dispersive spectrometry (WDS). All sites on samples and standards were measured with a 5 μm wide beam with 30 nA of current at incident electron beam energies of 10, 15, and 20 keV. Raw k -ratios were then imported into STRATAGEM thin film processing software to quantify thin film compositions.

S/TEM high-angle annular dark-field (HAADF) and selected area electron diffraction (SAED) images were acquired with a Thermo Fisher Scientific Spectra 200 transmission electron microscope operating at an accelerating voltage of 200 kV. Specimens for TEM were prepared from deposited films *via in situ* focused ion beam lift-out methods⁴² using a FEI Helios Nanolab 600i SEM/FIB DualBeam or a TESCAN Solaris SEM/FIB workstation. Chemical mapping was performed in the TEM using the super-X energy-dispersive X-ray spectroscopy (EDS) system equipped with four windowless silicon drift detectors, allowing for high count rates and chemical sensitivity (down to



0.5–1 at%). The EDS data were quantified using a multi-polynomial parabolic background and absorption correction in Velox.

Initial structure characterization of the films was performed with laboratory X-ray diffraction using a Bruker D8 Discover with Cu K α radiation equipped with a two-dimensional (2D) detector. Synchrotron grazing incidence wide angle X-ray scattering (GIWAXS) measurements were performed on selected samples at beamline 11-3 at the Stanford Synchrotron Radiation Lightsource, SLAC National Accelerator Laboratory. The data were collected with a Rayonix 225 area detector at room temperature using a wavelength of $\lambda = 0.97625$ Å, a 1° incident angle, a 150 mm sample-to-detector distance, and a beam size of approximately 50 μm vertical \times 150 μm horizontal. The detector images were calibrated with a LaB $_6$ standard, integrated with the Nika SAS package using Igor Pro,⁴³ and processed with PyFAI and pygix.^{44,45} Integrated data were averaged from 5 frames of 15 seconds each. LeBail fits of integrated plots were performed using Topas software by refining lattice parameters, sample displacements, and crystallite sizes,⁴⁶ and obvious outlier peaks from hot pixels were smoothed out manually.

Spectroscopic ellipsometry data were acquired at 65°, 70°, and 75° incident angles on a single row of all sample libraries using a J.A. Woollam Co. M-2000 variable angle ellipsometer. Complete EASE software was used to model the data by fitting the real and imaginary parts of the dielectric function with a four-layer model consisting of the silicon substrate, native silicon oxide, the Al $_{1-x}$ RE $_x$ N films, and surface roughness approximated with a standard mixed film/void Bruggeman EMA layer. The silicon and native oxide were modeled using well-known optical constants provided by the Complete EASE software. All the Al $_{1-x}$ RE $_x$ N film layers were modeled using Tauc-Lorentz and Cody-Lorentz semiconductor oscillator models which are established models for accurately fitting the imaginary part of the dielectric function of polycrystalline and/or amorphous materials while maintaining the Kramers–Kronig consistency.

Cathodoluminescence (CL) spectra were collected at room temperature on a JEOL JSM-7600 FESEM equipped with a Horiba H-CLUE CL system. An accelerating voltage of 5 kV and incident beam current of ~ 3 nA were used to excite excess carriers in the samples. CL spectra were acquired by scanning from 200–1150 nm with an integration time of 3 s, and three acquisitions were averaged to improve the signal-to-noise ratio.

Calculations

We calculated the variation in bandgap as a function of composition in the wurtzite Al $_{1-x}$ RE $_x$ N (RE = Pr and Tb; $x = 0.042, 0.125, \text{ and } 0.250$) alloys using the special quasi-random structure (SQS) approach⁴⁷ and chose 48-atom supercells to have manageable computational cost for GW calculations. We constructed the supercells using the Alloy Theoretic Automated Toolkit (ATAT)⁴⁸ and considered all the pair and triplet clusters within the maximal range of 4.5 and 3.2 Å, respectively. We used Vienna *Ab-initio* Simulation Package (VASP 5.4.4) to

calculate electronic structure. We fully relaxed the SQS supercells (ionic positions, cell size and shapes) with the cutoff total energy difference of 10^{-5} eV. For all the DFT-based calculations, we used Perdew–Burke–Ernzerhof (PBE) exchange–correlation functional. The planewave cutoff kinetic energy was set at 340 eV and self-consistency is ensured with cutoff total energy of 10^{-6} eV. The Brillouin zone was sampled using automatically generated Γ -centered Monkhorst–Pack k -point grids with length of 20 for structural relaxation. For GW calculations, we used Γ -centered $2 \times 2 \times 2$ k -point grids and used the PBE wavefunction of the optimized structures as the initial wavefunction. We fixed the wavefunction and iterated the eigenvalues to achieve self-consistency ($\Delta E_g < 0.1$ eV). The number of unoccupied bands was set to be at least ten times the number of occupied bands to obtain converged GW eigen energies.

Results and discussion

Synthesis and composition

Using reactive RF co-sputtering, we synthesized combinatorial Al $_{1-x}$ RE $_x$ N (RE = Pr, Tb) films on pSi (100) substrates intentionally making a one-dimensional (1D) compositional gradient. The co-sputtering schematic is shown in Fig. S1 (ESI†). Before depositing the samples with composition gradients, initial growth optimization was performed for crystalline Al $_{1-x}$ Tb $_x$ N films by varying substrate temperatures (400–700 °C), gas ratios (N $_2$:Ar = 3:1–1:3), and Tb target powers (30–75 W). The deposition parameters chosen (see Methods) were then used to grow the final series of Al $_{1-x}$ Tb $_x$ N and Al $_{1-x}$ Pr $_x$ N films, where the RE incorporation was controlled by varying the power applied to the RE sputtering gun. We note that the deposition parameters used here are not the same as in our previous work on Al $_{1-x}$ Gd $_x$ N,¹⁸ which employed a more nitrogen-rich process environment.

The composition of the films was measured with electron probe microanalysis (EPMA) across the compositional gradients, yielding RE compositions of $0.04 \lesssim x \lesssim 0.32$ for Al $_{1-x}$ Pr $_x$ N and $0.08 \lesssim x \lesssim 0.45$ for Al $_{1-x}$ Tb $_x$ N. The nitrogen content ratio N/(N + O), also probed by EPMA, is presented in Fig. S2 (ESI†); the highest N/(N + O) ratio was 0.90 for Al $_{1-x}$ Pr $_x$ N films, although it decreased to ~ 0.68 near $x \approx 0.1$. The average value for Al $_{1-x}$ Tb $_x$ N is higher, approximately 0.87.

To investigate the microstructure, composition, and uniformity of these materials, we investigated with STEM select films whose compositions as measured by EPMA were Al $_{0.94}$ Pr $_{0.06}$ N $_{0.96}$ O $_{0.25}$ (denoted Al $_{0.94}$ Pr $_{0.06}$ N), Al $_{0.86}$ Pr $_{0.14}$ N $_{0.96}$ O $_{0.25}$ (denoted Al $_{0.85}$ Pr $_{0.15}$ N), Al $_{0.91}$ Tb $_{0.07}$ N $_{0.93}$ O $_{0.04}$ (denoted Al $_{0.92}$ Tb $_{0.08}$ N), and Al $_{0.76}$ Tb $_{0.23}$ N $_{0.97}$ O $_{0.09}$ (denoted Al $_{0.79}$ Tb $_{0.21}$ N); see Table S1 (ESI†). STEM-HAADF, (Fig. 1 top left panels) reveals polycrystalline films with columnar grains, typical for sputtered films. STEM-EDS elemental mapping of Al $_{0.94}$ Pr $_{0.06}$ N, Al $_{0.92}$ Tb $_{0.08}$ N and Al $_{0.79}$ Tb $_{0.21}$ N films (Fig. 1a, b and Fig. S4, respectively, ESI†) have regions with homogeneous incorporation and regions with slight enrichment or depletion of Pr/Tb. In Al $_{0.94}$ Pr $_{0.06}$ N, Pr also appears coincident with O, suggesting that



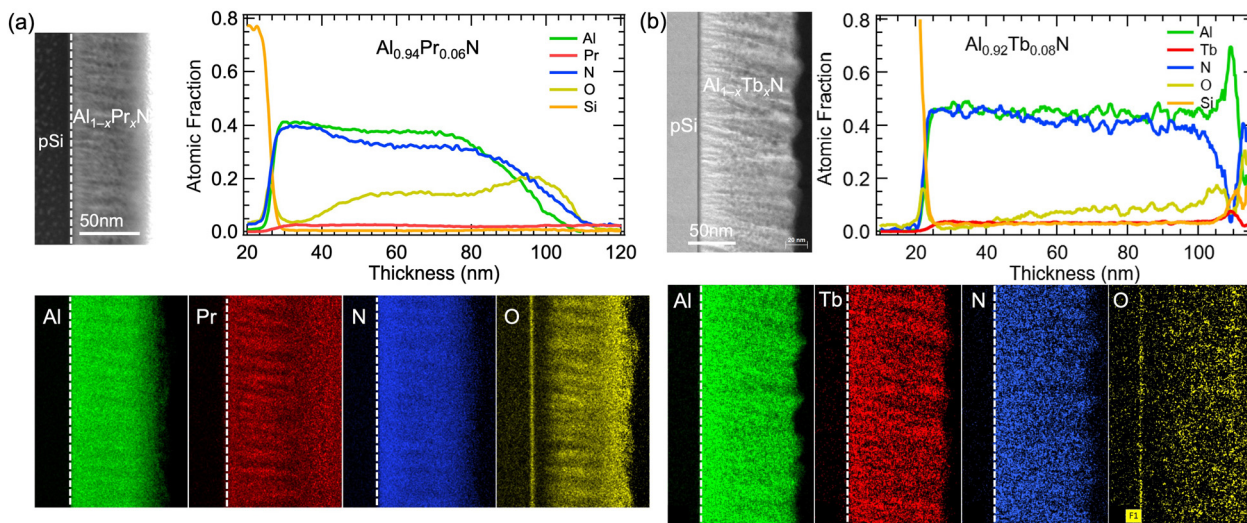


Fig. 1 STEM-HAADF image; EDS elemental mapping at the Al *K*-peak, Tb or Pr *L*-peak, N *K*-peak, and O *K*-peak; and EDS atomic % line profiles of (a) $\text{Al}_{0.94}\text{Pr}_{0.06}\text{N}$ and (b) $\text{Al}_{0.92}\text{Tb}_{0.08}\text{N}$ films on pSi substrates.

the Pr-rich regions oxidize more readily. However, there is relatively homogeneous incorporation of Pr in $\text{Al}_{0.85}\text{Pr}_{0.15}\text{N}$ (Fig. S3, ESI[†]). Line profiles extracted from the EDS maps (Fig. 1, bottom panels) show atomic fraction through the thickness of the films. The average surface compositions/atomic fractions of cations calculated from these line scans closely agree with those measured by EPMA (see Table S1, ESI[†]). Representative EDS spectra for $\text{Al}_{0.94}\text{Pr}_{0.06}\text{N}$ and $\text{Al}_{0.85}\text{Pr}_{0.15}\text{N}$ are in Fig. S5 (ESI[†]).

The oxygen contents in the bulk of these films are on the order of 5 at% (Table S1, ESI[†]), which is typical for nitride films deposited by sputtering.^{18,49,50} However, a gradual increase in oxygen towards the surface of the films suggests that a significant portion of this oxygen incorporation may have occurred post-deposition. We observe that the compositions

extracted from EPMA are much closer to those extracted from the EDS line profiles near the surface than in the bulk; for example, the stoichiometry extracted from EPMA for the $\text{Al}_{0.92}\text{Tb}_{0.08}\text{N}$ film is $\text{Al}_{0.91}\text{Tb}_{0.08}\text{N}_{0.96}\text{O}_{0.17}$, while EDS yields $\text{Al}_{0.92}\text{Tb}_{0.07}\text{N}_{0.8}\text{O}_{0.15}$ near the surface. This is consistent with EPMA being more sensitive to the surface region. Table S1 (ESI[†]) presents the direct comparisons of all stoichiometries of the three films measured by EDS and EPMA. We also note that the spike in oxygen visible at the substrate interface is from the native oxide layer on Si wafers.

Crystal structure

To understand the crystal structure as a function of RE content, we performed laboratory XRD and synchrotron GIWAXS on the $\text{Al}_{1-x}\text{RE}_x\text{N}$ (RE = Pr, Tb) combinatorial films. Fig. 2 displays

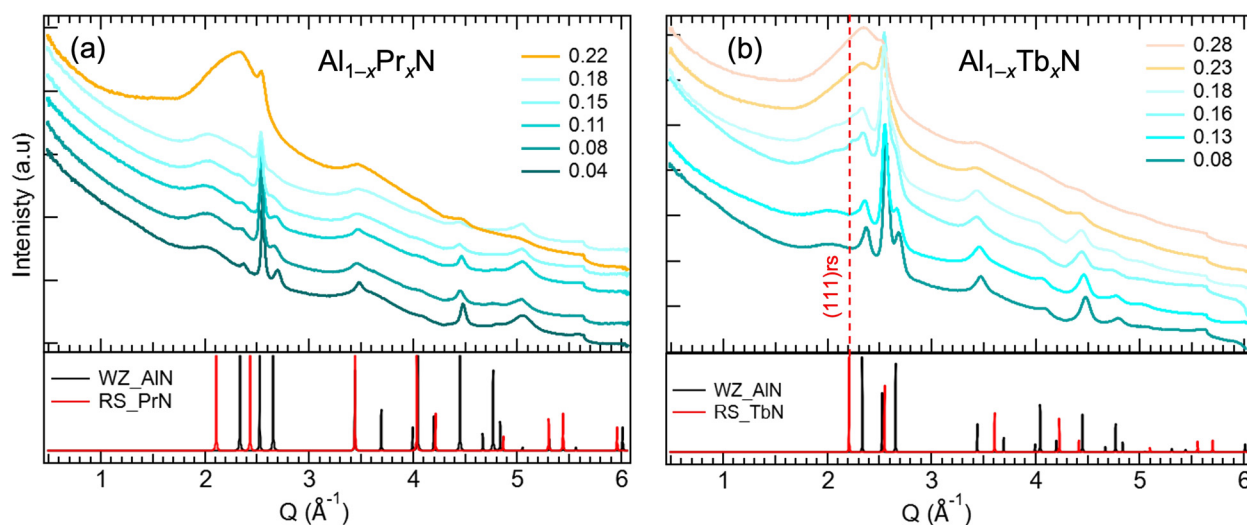


Fig. 2 (a) and (b) Select integrated synchrotron GIWAXS data of (a) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ combinatorial films with $x = 0.04$ to 0.22 , and (b) $\text{Al}_{1-x}\text{Tb}_x\text{N}$ combinatorial films with $x = 0.08$ to 0.28 . The data are shifted vertically for visual clarity.



selected integrated patterns of $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films with a range of RE incorporation, along with the calculated patterns for the end members wz-AlN and rs-REN. As seen from Fig. 2a, all of the observed peaks in the $\text{Al}_{1-x}\text{Pr}_x\text{N}$ patterns up to $x \approx 0.22$ correspond to the wurtzite phase. There are no peaks that match a rocksalt phase (PrN or Al-substituted PrN). Above $x \gtrsim 0.22$, the peaks become weaker and broader, indicating significant disorder in the crystalline phase that is consistent with the presence of amorphous material (Fig. S7a and b, ESI†). Select data from $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films (Fig. 2b) show that the peaks match with reference wz-AlN peaks for approximately $x \lesssim 0.15$. However, the pattern for $x \approx 0.16$ shows an additional rs-TbN(111) peak at $Q = 2.2 \text{ \AA}^{-1}$, close to the wz-(100) peak. Additional GIWAXS patterns are shown in Fig. S7e and f (ESI†). Together, the data indicate that $\text{Al}_{1-x}\text{Tb}_x\text{N}$ crystallizes in a phase-pure wurtzite structure below $x \approx 0.16$ and mixed wz + rs phases for $0.16 \lesssim x \lesssim 0.28$. The onset of amorphization is observed at $x \approx 0.28$ and extends up to the highest measured Tb content of $x \approx 0.46$ (Fig. S7c and d, ESI†). Phase diagrams are shown in Fig. 3c and d for RE = Pr and Tb, respectively.

The close d -spacings of some of the wz-AlN and rs-REN peaks and the gradual shifting of the observed peaks with x complicates the phase identification with just 1D integrated patterns. Therefore, we inspect the GIWAXS 2D detector images by analyzing the tilt angles corresponding to the observed peaks to perform a detailed phase assessment. Fig. 3a and b show the GIWAXS 2D detector images for select x -values critical for phase distinction in $\text{Al}_{1-x}\text{RE}_x\text{N}$ films. The pure wurtzite phase in $\text{Al}_{1-x}\text{Pr}_x\text{N}$ up to $x \approx 0.22$ is further corroborated by the presence of additional wurtzite peaks with their corresponding d -spacings and tilt angles, Fig. 3a. For $\text{Al}_{1-x}\text{Tb}_x\text{N}$, the detector images in Fig. 3b show that only wurtzite peaks are present for $x \approx 0.08$, and they are maintained up to $x \lesssim 0.16$ (Fig. S7e, ESI†). These are the highest reported substitution levels of both Tb^{3+} and Pr^{3+} into wurtzite AlN. Previous reports on Tb^{3+}

substitution were limited to Tb contents of $\sim 2\%$, while all reports on Pr^{3+} involve ion implantation with concentrations similar to that of Tb^{3+} . In $\text{Al}_{1-x}\text{Tb}_x\text{N}$, a rs-(111) peak along with the wurtzite peaks confirms mixed wz + rs phases between $x \approx 0.16$ and $x \approx 0.28$ (Fig. 1b and Fig. S7f, ESI†). The amorphous nature of $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films for compositions $x \gtrsim 0.28$ is confirmed by 2D detector images in Fig. S7c and d (ESI†).

The detector images for both RE = Pr and Tb films in the wurtzite phase display texturing consistent with semi-oriented films, similar to our previous work on $\text{Al}_{1-x}\text{Gd}_x\text{N}$ films.¹⁸ Laboratory XRD data collected with a much smaller area detector reveal only the wz-(002) peak in the phase-pure wurtzite region (Fig. S6, ESI†), which would be consistent with c -axis texture, as is often observed for AlN-base wurtzite films.^{51,52} It is worth noting that lab XRD measurements along the surface normal may miss important crystallographic details such as off-axis diffraction and in-plane lattice parameters.

In both $\text{Al}_{1-x}\text{RE}_x\text{N}$ (RE = Pr, Tb), the obvious shifting of the wurtzite peaks towards lower angles with increasing x (Fig. 2) implies that the lattice parameters increase upon substituting RE cations onto the Al sites. To quantify this, LeBail fits were performed on the integrated GIWAXS data to extract the lattice parameters and unit cell volumes for the phases present (Fig. S8, ESI†). The lattice parameters (Fig. S9, ESI†) and unit cell volume (Fig. 3c and d) increase with x while the films maintain a phase-pure wurtzite structure. This trend is consistent with successful substitution of RE^{3+} cations in wz-AlN and with prior work on $\text{Al}_{1-x}\text{Gd}_x\text{N}$ films.¹⁸ Interestingly, we observe that the volume increase of phase-pure wurtzite $\text{Al}_{1-x}\text{Tb}_x\text{N}$ is larger than that of phase-pure wurtzite $\text{Al}_{1-x}\text{Pr}_x\text{N}$ even though Tb^{3+} is smaller than Pr^{3+} . The different volume increase may be caused by oxygen impurities observed by EMPA or other defects that are not the focus of this study. The trend of increasing unit cell volume in $\text{Al}_{1-x}\text{Tb}_x\text{N}$ deviates once the film changes from phase-pure wurtzite to mixed wz + rs phases, Fig. 3d. In this

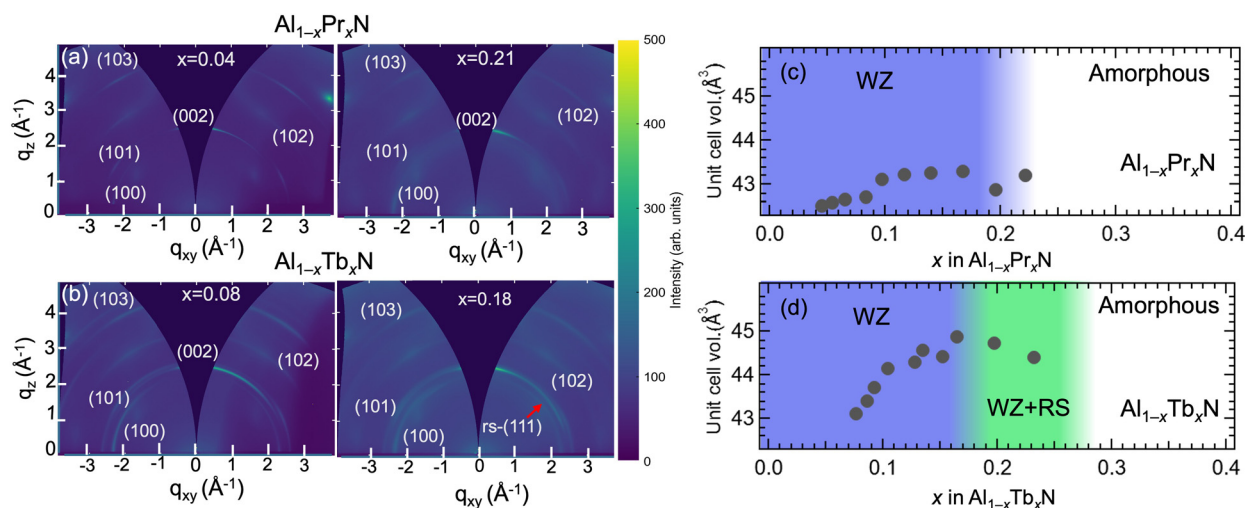


Fig. 3 (a) and (b) GIWAXS 2D detector images of $\text{Al}_{1-x}\text{RE}_x\text{N}$ at several x values. (a) 2D detector images of $\text{Al}_{0.96}\text{Pr}_{0.04}\text{N}$ and $\text{Al}_{0.79}\text{Pr}_{0.21}\text{N}$ indexed to a wurtzite phase. (b) 2D detector images of $\text{Al}_{0.92}\text{Tb}_{0.08}\text{N}$ indexed to a wurtzite phase and $\text{Al}_{0.82}\text{Tb}_{0.18}\text{N}$ indexed to both wurtzite and rocksalt phases. (c) and (d) Evolution of unit cell volumes with substitution of (c) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and (d) $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films. The phases present are marked.



mixed-phase regime of $\text{Al}_{1-x}\text{Tb}_x\text{N}$, the data were fitted with both wz and rs phases. The decrease in unit cell volume could imply that the Tb^{3+} cations may not have substituted to Al sites once the mixed phase appears despite the wz-c and rs lattice constants increase within this range, Fig. S9b (ESI†). A decrease in a -lattice constants for the mixed phase region is observed, which dominates the unit cell volume.

The films investigated *via* STEM-EDS ($\text{Al}_{0.94}\text{Pr}_{0.06}\text{N}$, $\text{Al}_{0.85}\text{Pr}_{0.15}\text{N}$, $\text{Al}_{0.92}\text{Tb}_{0.08}\text{N}$, and $\text{Al}_{0.79}\text{Tb}_{0.21}\text{N}$) were further investigated with SAED and STEM-DF or STEM-BF imaging, shown in Fig. S10 (ESI†). The SAED data for $\text{Al}_{0.94}\text{Pr}_{0.06}\text{N}$ are consistent with the wurtzite structure (Fig. S10a, ESI†). The SAED data for $\text{Al}_{0.85}\text{Pr}_{0.15}\text{N}$ are more amorphous: they display a diffuse ring at $d \approx 2.84 \text{ \AA}$, consistent with the GIWAXS data (Fig. S10b, ESI†). Rings for additional wurtzite peaks are too weak to be observed, consistent with the high oxygen content of this sample. STEM-BF imaging of $\text{Al}_{0.92}\text{Tb}_{0.08}\text{N}$ reveals textured polycrystalline microstructures with columnar grains with grain sizes approximately $\sim 5 \text{ nm}$ (Fig. S10c, ESI†). Fast Fourier transforms (FFTs) from two regions of interest are consistent with a wurtzite phase. It is evident from the STEM-BF image and FFTs patterns that some regions between the grains appear to be amorphous, and the degree of crystallinity varies throughout the film. STEM-BF imaging $\text{Al}_{0.79}\text{Tb}_{0.21}\text{N}$ (Fig. S10, ESI†) reveals textured a polycrystalline film, and several FFTs are consistent with a wurtzite-dominated phase, despite GIWAXS

data showing wz + rs phases for $x \approx 0.21$ (Fig. 3b and d). This may be due to microscopic segregation of wz and rs phases.

The fact that a wurtzite structure is maintained with incorporation of Pr and Tb into AlN up to approximately $x \approx 0.2$ yields similar results to our previous work on $\text{Al}_{1-x}\text{Gd}_x\text{N}$, which found Gd incorporation up to $x \approx 0.24$.¹⁸ This is also consistent with calculations of the critical composition x_c performed previously for $\text{Al}_{1-x}\text{RE}_x\text{N}$ (RE = Pr, Tb), finding similar behavior to $\text{Al}_{1-x}\text{Gd}_x\text{N}$.¹⁸ The slightly lower incorporation in the current work may be due to less optimization of growth parameters performed in the current study compared to the $\text{Al}_{1-x}\text{Gd}_x\text{N}$ work, and possibly to the less nitrogen-rich growth environment employed here. We hypothesize that the observation of a rocksalt phase in $\text{Al}_{1-x}\text{Tb}_x\text{N}$ (but not $\text{Al}_{1-x}\text{Pr}_x\text{N}$ or $\text{Al}_{1-x}\text{Gd}_x\text{N}$) might arise from its slightly lower electronegativity (and therefore less ionic bonds) compared to Pr^{3+} and Gd^{3+} , as higher bond ionicity was shown to stabilize $\text{Al}_{1-x}\text{Sc}_x\text{N}$.⁵³

Optoelectronic properties

To investigate the bandgap change as a function of RE composition, we performed spectroscopic ellipsometry (SE) measurements across the compositionally-graded films of $\text{Al}_{1-x}\text{RE}_x\text{N}$ (RE = Pr, Tb). Absorption coefficients (α) extracted from the SE data are plotted in Fig. 4a and b. To avoid the errors intrinsic to Tauc analysis, we define an optical absorption cutoff as the energy when $\alpha = 5 \times 10^4 \text{ cm}^{-1}$ ($E_{\alpha=5 \times 10^4}$),^{18,54} shown as the

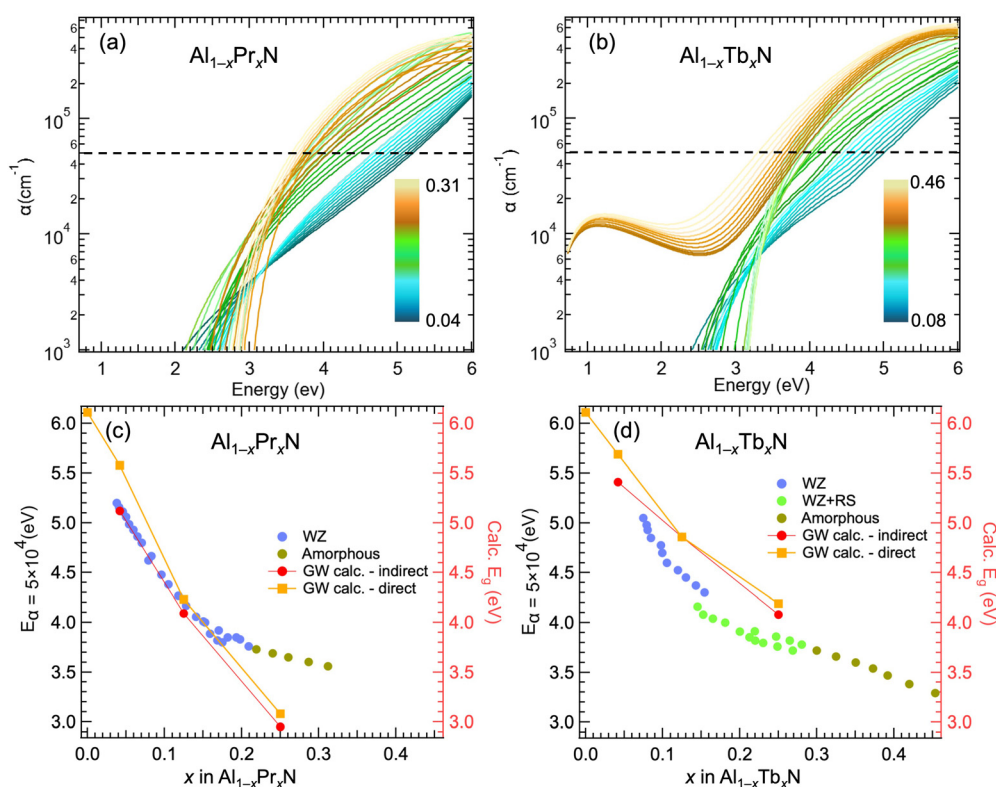


Fig. 4 (a) and (b) Absorption coefficients (α) of all the compositions of combinatorial (a) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and (b) $\text{Al}_{1-x}\text{Tb}_x\text{N}$ thin films extracted from spectroscopic ellipsometry measurements. (c) and (d) The energy corresponding to $\alpha = 5 \times 10^4 \text{ cm}^{-1}$ ($E_{\alpha=5 \times 10^4}$, shown by the dashed lines in a and b) and GW bandgaps as a function of x in wurtzite (c) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and (d) $\text{Al}_{1-x}\text{Tb}_x\text{N}$.



dashed line in Fig. 4a. The extracted $E_{\alpha=5 \times 10^4}$ values, which should follow the same trend as the bandgap, are plotted as a function of RE incorporation in Fig. 4c and d, along with both direct and indirect bandgaps calculated by the GW method for wurtzite $\text{Al}_{1-x}\text{RE}_x\text{N}$, which are modeled by the special quasi-random structure approach (see Experimental for details). The calculated bandgaps fall off quickly with RE incorporation, which is expected since rocksalt RE nitrides have small bandgaps (<1.5 eV).⁵⁵

Fig. 4c and d show that the experimental $E_{\alpha=5 \times 10^4}$ extracted for both $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and $\text{Al}_{1-x}\text{Tb}_x\text{N}$ decrease with increasing RE substitution, similar to the trend measured previously for $\text{Al}_{1-x}\text{Gd}_x\text{N}$.¹⁸ For both materials, the $E_{\alpha=5 \times 10^4}$ values decrease monotonically while the films maintain a pure wurtzite phase. In $\text{Al}_{1-x}\text{Pr}_x\text{N}$, the slope of the $E_{\alpha=5 \times 10^4}$ values changes when the film transitions from the wurtzite phase to amorphous (Fig. 4c). In $\text{Al}_{1-x}\text{Tb}_x\text{N}$, the slope similarly changes between the wurtzite phase, the wz + rs region, and the amorphous region (Fig. 4d). Together, the data suggest that the slope of the absorption onset, which is proportional to the bandgap, is dependent on the phases present.

Significant sub-gap absorption is visible in the $\text{Al}_{1-x}\text{Tb}_x\text{N}$ samples when $x \gtrsim 0.28$, which corresponds to the amorphous region. We hypothesize this might be due either to a mixture of higher-bandgap wz-like (*i.e.*, tetrahedral) and lower-bandgap rs-like (*i.e.*, octahedral) local coordination in the amorphous phase or perhaps to RE-rich regions, which would have a lower bandgap. Ellipsometry measurements in $\text{Al}_{1-x}\text{Gd}_x\text{N}$, which did not exhibit a crystalline rs phase at compositions up to $x \approx 0.24$, also did not exhibit this level of sub-gap absorption in the amorphous region, consistent with this hypothesis.

Luminescence properties

To study the luminescence properties of these alloys, CL measurements were performed at room temperature on our $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films for a range of x values (Fig. 5). The CL spectra of $\text{Al}_{1-x}\text{Pr}_x\text{N}$ films show three main emission lines (1, 2, and 3) ranging from blue/green (~ 527 nm) to red (~ 653 nm), consistent with the previously reported luminescence spectra for Pr^{3+} cations within III-nitride hosts.^{22,24,56} Following previous assignments, the stronger line at 526 nm (1) corresponds to the intra 4f-shell $^3\text{P}_1 \rightarrow ^3\text{H}_5$ transition, and the weaker lines (2 and 3) arise from the $^3\text{P}_0 \rightarrow ^3\text{H}_5$ and $^3\text{P}_0 \rightarrow ^3\text{F}_2$ transitions, Fig. 5b. The observed emission lines are consistent with the reference spectra by ± 5 nm and are tabulated in Table S2 (ESI†). It was previously reported that Pr^{3+} cations implanted in GaN exhibited an intense red emission line at 650 nm^{57,58} and that Pr^{3+} in AlN in an amorphous phase yielded an intense green line at 526 nm along with reasonable intensity in the red region that increased in the crystalline phase.^{22,56} These previous nitride hosts are MBE-, sputtered-, and MOCVD-deposited films with implanted Pr^{3+} at low concentrations ($\sim 10^{14}$ – 10^{15} cm⁻²); we note that structures and phase confirmations are not presented.^{24,56} It is interesting that our crystalline wurtzite films show dominant emission in the green; the

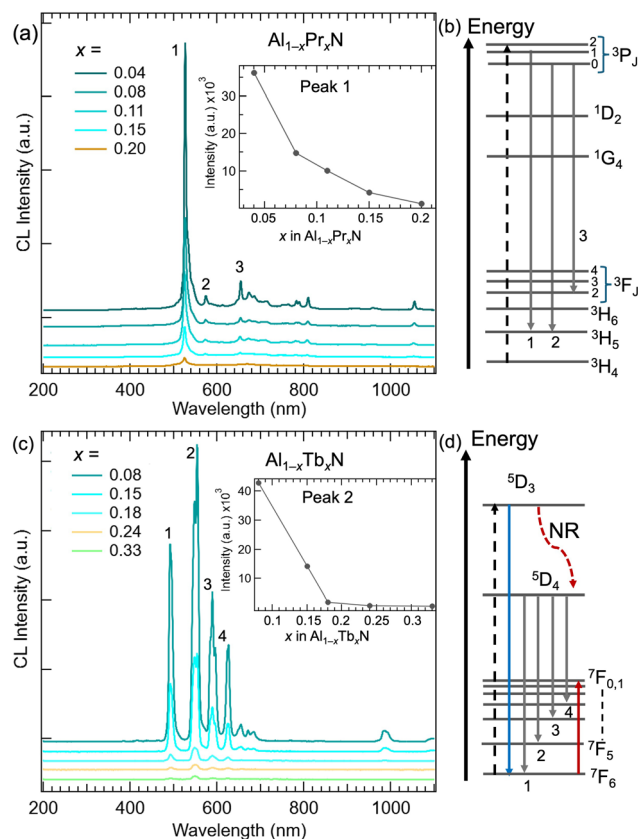


Fig. 5 Room temperature CL measurements on (a) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and (b) $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films for various concentrations. Spectra are shifted vertically for clarity. Schematics of electronic transitions corresponding to the observed emission lines in (b) $\text{Al}_{1-x}\text{Pr}_x\text{N}$ and (d) $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films. The cross-relaxation process is shown with red arrows in (d). Insets of panels (a) and (c): Intensities of the strongest CL emission line as a function of RE³⁺ composition (x).

red emission is significantly suppressed, in apparent contrast to earlier results.

The gradual decrease in CL intensity with Pr incorporation, shown in the inset of Fig. 5a, is attributed to concentration quenching, which is commonly observed with increasing RE concentration beyond a certain level and is independent of the phase evolution across the compositional range.⁵⁹ The significant variation in the green/red emission ratio we observe is most likely associated with a higher fraction of the Pr on the Al substitutional site, as opposed to the interstitial and defect related positions that can be associated with implanted films.

Fig. 5c shows the CL spectra for $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films; multiple emission lines occur within the visible region resulting from intra 4f-shell transitions of Tb^{3+} . The green region comprises the strongest emission line at 554 nm (2) and other relatively strong lines at 492 and 589 nm (1 and 3), while emission lines in the yellow region (4 and others at higher wavelengths) are weaker. All observed peaks are consistent with the previously reported spectra and characteristic emissions mediated by Tb^{3+} and are tabulated in Table S2 (ESI†), along with the transitions from which they originate.^{25,26,60,61} We note that the previously reported $^5\text{D}_3$ to $^7\text{F}_j$ ($j = 6, 5, 4$) transitions within the blue region



are not visible in our films. This is likely due to variations in cross-relaxation mechanisms that control the radiative/non-radiation ratios since the cross-relaxation process (see Fig. 5d) dominates with increasing Tb^{3+} concentrations—leading to decreased emission intensities in the blue region accompanied by an increase in emission intensities in the green region.⁶¹

The intensity of the strongest peak (2) shows a significant drop at higher Tb concentrations ($x \geq 0.15$), which we attribute to concentration quenching (inset of Fig. 5c). Interestingly, we observe reasonable intensities of the green emission lines (1, 2, and 3) in our films even at higher Tb^{3+} concentrations ($x \approx 0.08$) compared to previous work, in which those lines were almost quenched at concentrations that fully suppressed the $^5\text{D}_3$ to $^7\text{F}_j$ peaks ($x \geq 0.01$).^{21,27,62} Our data are also in contrast to a previously reported $\text{Al}_{1-x}\text{Tb}_x\text{N}$ film with $x \lesssim 0.11$, which showed quenching of green ($^5\text{D}_4 \rightarrow ^7\text{F}_j$) emission lines above $x \approx 0.05$.²⁸

In this family of materials, oxygen defects were reported to produce a broad emission peak in the UV centered around ~ 380 nm, arising from $(\text{V}_{\text{Al}}\text{-O}_{\text{N}})^{-/2-}$ defect complexes where three oxygen impurity defects (O_{N}) create one Al vacancy (V_{Al}).^{63,64} However, we do not observe a UV peak in either $\text{Al}_{1-x}\text{Pr}_x\text{N}$ or $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films across the whole substitution range (x). This suggests a different form of the primary oxygen-related defect(s) in these films and may be worthy of future study. We note that the relationship between synthesis method (ion implantation, sputtering, bulk synthesis, *etc.*), level of crystallinity, crystalline phases present (wz, rs, *etc.*), RE^{3+} cation position within the matrix (substitutional or interstitial), type and level of defects, and emission is not yet fully understood and is likely complex.^{27,65,66} We hypothesize that stabilizing the wurtzite phase in $\text{Al}_{1-x}\text{RE}_x\text{N}$ up to higher RE composition could offer an additional knob to selectively tailor the emission lines and enhance their relative intensities, especially in co-substituted films.

Conclusions

Expanding studies of metal-substituted AlN films to rare earth cation substitution offers the potential to unlock novel functionalities. Here, we have successfully synthesized a series of $\text{Al}_{1-x}\text{RE}_x\text{N}$ (RE = Pr, Tb) thin films across a broad compositional space using rf co-sputtering. Using synchrotron GIWAXS measurements, we confirmed that $\text{Al}_{1-x}\text{Pr}_x\text{N}$ films maintained a wurtzite structure for $x \lesssim 0.22$ and became amorphous for $x \geq 0.22$. The $\text{Al}_{1-x}\text{Tb}_x\text{N}$ films remained phase-pure wurtzite for $x \lesssim 0.16$; showed a mixture of wurtzite and rocksalt phases for $0.16 \lesssim x \lesssim 0.28$; and became amorphous at $x \geq 0.28$. A monotonic increase in the unit cell volume with x within the wurtzite phase suggests the substitution of RE^{3+} onto the Al sites. This is the highest substitution of Pr^{3+} and Tb^{3+} into phase-pure wurtzite III-nitrides that has been reported to date, and it is comparable to the level of RE incorporation reported in our previous work on $\text{Al}_{1-x}\text{Gd}_x\text{N}$.

Ellipsometry measurements show a gradual decrease in the absorption onset of the films with increasing x , confirming

theoretical predictions of the decrease in bandgap with alloying. The presence of Pr^{3+} and Tb^{3+} in the respective films is also confirmed by their signature emission lines from cathodoluminescence measurements. At these higher levels of incorporation for Pr, Tb and Gd in AlN, there is increased opportunity to tailor the relative intensity of luminescence across a broad range of the visible spectrum, especially with the future potential of co-doping. Further optimization of film quality may be necessary to enable additional functionality, like potential ferroelectricity. The demonstration of high-throughput synthesis along with our investigation of the composition-phase-properties relationship(s) of these materials can help establish the design rules for a broad range of AlN-based thin films.

Author contributions

Binod Paudel: investigation, writing – original draft. John S. Mangum: investigation, writing – review & editing. Christopher L. Rom: investigation, writing – review & editing. Kingsley Egbo: investigation. Cheng-Wei Lee: investigation, writing – review & editing. Harvey Guthrey: Investigation. Sean Allen: investigation. Nancy M. Haegel: funding acquisition, project administration, resources, supervision, writing – review & editing. Keisuke Yazawa: supervision, writing – review & editing. Geoff L. Brenneka: funding acquisition, project administration, supervision, writing – review & editing. Rebecca W. Smaha: conceptualization, supervision, writing – review & editing.

Data availability

Data that support the findings of this study are openly available in the National Renewable Energy Laboratory (NREL) high-throughput experimental materials database at <https://hitem.nrel.gov>. Additional data that support the findings of this study are available from the corresponding author upon reasonable request.

Conflicts of interest

There are no conflicts to declare.

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